



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Patent**

Applicant(s): Daniel YAP ) Re: Information Disclosure  
Serial No.: 10/772,112 ) Statement  
Filed: February 3, 2004 ) Group: 2818  
For: "WAVEGUIDE-BONDED OPTOELECTRONIC ) Examiner: Mai Huong C. Tran  
DEVICES" )  
For: "WAVEGUIDE-BONDED OPTOELECTRONIC ) Our Ref: B-4246DIV 621598-8  
DEVICES" )  
For: "WAVEGUIDE-BONDED OPTOELECTRONIC ) Date: August 16, 2004  
DEVICES"

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA, 22313-1450

Sir:

In accordance with the Applicant's duty to disclose information which may be material to the examination of this application, the undersigned respectfully requests that the Examiner consider on the merits the documents listed on the enclosed Form PTO-1449 (modified) before issuing the next Office Action on the merits. We are enclosing herewith a copy of each document listed on the enclosed Form PTO-1449 (modified).

The filing of this Information Disclosure Statement (IDS) shall not be construed as a representation that a search has been made (37 C.F.R. 1.97(g)), an admission that the information cited is, or is considered to be, material to patentability, or that no other material information exists.

This IDS is being submitted after receiving an Office Action on the merits, but before receiving a Final Rejection or Notice of Allowance, and is accompanied by a check for \$180, which is the fee specified in 37 C.F.R. § 1.17(p). Thus, this IDS should be fully considered on the merits, in accordance with 37 C.F.R. § 1.97(d).

This paper is being filed with a response to the Office Action issued May 17, 2004.

08/19/2004 EAREGAY1 00000024 10772112

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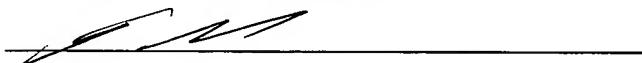
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The filing of this Information Disclosure Statement shall not be construed as an admission against interest in any manner. (Notice of January 9, 1992, 1135 O.G. 13-25, at 25.) Also, the filing of this Information Disclosure Statement does not constitute a response to the pending Office Action, mailed February 13, 2002.

The person making this statement is the practitioner who signs below on the basis of information supplied by an individual associated with the filing and prosecution of this application (37 C.F.R. § 1.56(c)) and on the basis of information in the practitioner's file.

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first-class mail in an envelope addressed to the "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450", on August 16, 2004 by Shana Morda.



Respectfully submitted,



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Enclosures: Form PTO-1449 (modified) (1 page)  
Copy of documents listed on Form PTO-1449 (modified)  
Check for \$180.00

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Form PTO-1449 (Modified)	ATTY DOCKET NO. B-4246DIV 621598-8	U.S. SERIAL NO. 10/772,112
LIST OF PATENTS AND PUBLICATIONS STATEMENT	APPLICANT(S) Daniel YAP	
	FILING DATE February 3, 2004	GROUP 2818

**U.S. PATENT DOCUMENTS**

EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE or 102(e) DATE IF APPROPRIATE

**FOREIGN PATENT DOCUMENTS**

	DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION YES/NO

**OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)**

Chan, W.K., et al., "Grafted Semiconductor Optoelectronics," <i>IEEE Journal Of Quantum Electronics</i> , Vol. 27, No. 3, pp. 717-725 (March 1991).
Yi-Yan, A., et al., "Semiconductor-Film Grafting: A New Approach to OEICs," <i>Circuits &amp; Devices</i> , pp. 26-30 (May 1992).

EXAMINER	DATE CONSIDERED

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.